802.11g Wireless LAN SiP Module (WM-BG-MR -01)



Data Sheet Apr 14th. 2006 Rev 2.5

Data Sheet of 802.11g WM-BG-MR -01 B2B Wireless Lan +BT Combo Module

Introduction

The 802.11 Wireless SiP module WM-BG-MR-01 which refers as "SiP-g combo module" is a small size module that provides full function of 802.11g/b and Bluetooth class 2 on a tiny module via 60 pins board to board connector.

This multi- functionality and board to board physical interface provides 16 bit PC Card /CF+ bus interface for WiFi and UART for Bluetooth.

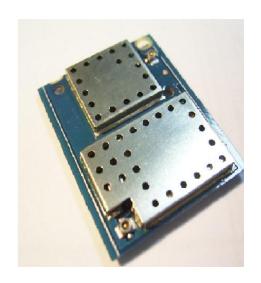
The small size & low profile physical design make it easier for system design to enable high performance wireless connectivity without space constrain. The low power consumption (Sleep mode 1.2 mA) and excellent radio performance make it the best solution for OEM customers who require embedded 802.11g Wi-Fi + Bluetooth features, such as, Wireless PDA, Scanner Smart phone, Media player slim type Notebook, barcode ,mini-Printer, VoIP phone etc.

For 802.11g feature, Marvell "Libertas" chipset solution is adopted and CSR BlueCore 03-ROM for Bluetooth. The Radio architecture & high integration MAC/BB chip provide excellent sensitivity with rich system performance. Two antenna connectors provide antenna connectivity for each function.

WM-BG-MR-01 provides outstanding BT WiFi coexistence solution through internal 2 wires , hardware interface to optimized connection with CSR Bluetooth solution even without good antenna isolation between BT & WiFi module.

In addition to WEP 64/128, WPA and TKIP, AES is supported to provide the latest security requirement on your network.

For the software and driver development, USI provides extensive technical document and reference software code for the system integration under the agreement of Marvell International Ltd.



Features

- Lead Free design which supporting Green design requirement, RoHS Compliance.
- 2 wires, hardware signaling BT WiFi coexistence supported.
- Small size suitable for low volume system integration.PCM audio interface supported.
- Low power consumption & excellent power management performance, extend battery life.
- 2.412-2.484 GHz two SKUs for worldwide market.
- Easy for integration into mobile and handheld device with flexible system configuration and antenna design.



| | Change Sheet | | | | | | |
|------|--------------|-------------------------------------|-----|---|--|--|--|
| Rev. | Date | Approval & Date | | | | | |
| 1.0 | 10/1/04 | Page All | All | Change(s) Draft version for Review | | | |
| 2.0 | | 6,15, 17,22 ,23, 25~2 7 | All | 1. Executive summary for target available date from "the middle of 1Q 2005" to "the end of 2Q" 2. Output power for 11g is 13 +/- 1dBm 3. Update the mech. Drawing . 4. Modify the function description for Marvell Transceiver from "8010" to "8015" 5. Correct the Pin Definition for xxx_B is for "active_high" 6. add description for Pin 28;36;43;58; which reserved for BT's PCM interface, | | | |
| 2.1 | 04/18/05 | 25 | | make it no confuse in customer reading. 1. correct the pin definition for Pin24 from "Control signal to enable engineer testing mode " to "Output signal to indicate 16 bit IO operation. This signal is connected to ground at module side to indicate 16 bit IO" then Type is for GND to indicate the module under the mode for 16bit IO. | | | |
| 2.2 | 04/28/05 | 24 | | 1. Pin A10 pin definition change from "the pin is open to "This address range is mainly used for accessing the CIS in Memory Mode. Signal HA0 is not used in word access mode.", Type change from "No connection" to "Input, PD,5VT" | | | |
| 2.3 | 10/31/05 | 2, 8, 9 | | Power Consumption | | | |
| 2.4 | 11/08/05 | 25,26 , 27 | | Add SDIO Pin Definition | | | |
| 2.5 | 04/14/06 | 17, all | | Specify connectors for BT and WiFi Add page numbers | | | |

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1. EXECUTIVE SUMMARY

The WM-BG-MR-01 module - is one of the product families in USI's product offering, targeting for system integration requiring a smaller form factor. It also provides the standard migration to high data rate to USI's current SIP customers. The WM-BG-MR-01 module providing B to B type connector is provided as option for customers, who want to have Board to board type assembly.

This document outlines the product requirements for a "system in Package" 802.11g/(b) combo module – here after referred as WM-BG-MR-01 Module.

This product is targeted for first shipments by end of **2Q 2005** and is designated for use in embedded applications mainly in the mobile device, which required, small size and high data rate wireless connectivity. The application such as, Wireless PDA, slim type Notebook, Media Adapter, Barcode scanner, mini-Printer, VoIP phone, Data storage device could be the potential application for wireless WM-BG-MR-01.

2. DELIVERABLES

The following products and software will be part of the product.

- ♣ WM-BG-MR-01 Module with packaging
- Evaluation kits, including application (CF, PCMCIA Adapter card, RF cable with SMA connector, antenna),
- ♣ Software utility which supporting customer for integration, performance test, and homologation. Capable of testing, loading (firmware) and configuring (MAC, CIS) for the WM-BG-MR-01 module.
- Unit Test / Qualification report
- Product Specifications.
- Agency certification pre-test report base on adapter boards

3. REFERENCE DOCUMENTS

| C.I.S.P.R. Pub. 22 | "Limits and methods of measurement of radio interference characteristics of information technology equipment." International Special Committee on Radio Interference (C.I.S.P.R.), Third Edition, 1997. |
|-------------------------|---|
| CB Bulletin No. 96A | "Adherence to IEC Standards: "Requirements for IEC 950, 2 nd Edition and Amendments 1 (1991), 2(1993), 3 (1995) and 4(1996). Product Categories: Meas, Med, Off, Tron." IEC System for Conformity Testing to Standards for Safety of Electrical Equipment (IECEE), April 2000. |
| CFR 47, Part 15-B | "Unintentional Radiators". Title 47 of the Code of Federal Regulations, Part 15, FCC Rules, Radio Frequency Devices, Subpart B. |
| CFR 47, Part 15-C | "Intentional Radiators". Title 47 of the Code of Federal Regulations, Part 15, FCC Rules, Subpart C. URL: http://www.access.gpo.gov/nara/cfr/waisidx_98/47cfr15_98.html |
| CSA C22.2 No. 950-95 | "Safety of Information Technology Equipment including Electrical Business Equipment, Third Edition." Canadian Standards Association, 1995, including revised pages through July 1997. |
| EN 60 950 | "Safety of Information Technology Equipment Including Electrical Business Equipment." European Committee for Electrotechnical Standardization (CENELEC), 1996, (IEC 950, Second Edition, including Amendment 1, 2, 3 and 4). |
| IEC 950 | "Safety of Information Technology Equipment Including Electrical Business Equipment." European Committee for Electrotechnical Standardization, Intentional Electrotechnical Commission. 1991, Second Edition, including Amendments 1, 2, 3, and 4. |
| IEEE 802.11 | "Wireless LAN Medium Access Control (MAC) And Physical Layer (PHY) Specifications." Institute of Electrical and Electronics Engineers. 1999. |

4. TECHNICAL SPECIFICATION

The WM-BG-MR-01 is a B2B type assembly part, technical supporting, package requirement needs to be taken into consideration.

4.1. ABSOLUTE MAXIMUM RATING

| Supply Power | Max +3.6 Volt | |
|---------------------------|----------------------|-------------------------------------|
| Non Operating Temperature | - 40° to 85° Celsius | |
| Voltage ripple | +/- 2% | Max. Values not exceeding Operating |
| | | voltage |

4.2. RECOMMENDABLE OPERATION CONDITION

4.2.1. TEMPERATURE, HUMIDITY

The WM-BG-MR-01 module has to withstand the operational requirements as listed in the table below.

| Operating Temperature | -20° to 60° Celsius | |
|-----------------------|---------------------|-----------------------------------|
| Humidity range | Max 95% | Non condensing, relative humidity |

4.2.1. VOLTAGE AND CURRENT

Power supply for the WM-BG-MR-01 module will be provided by the host via the power pins. There will be separated power source for WiFi and Bluetooth.

802.11 g(b) *Voltage : VDD*

| Operating Voltage | 3.3 Volt | +- 10% |
|-------------------|----------|------------------------|
| Current | | |
| Transmit | 480 mA | Typical @54Mbps, 12dbm |
| Receive | 275 mA | Typical@54Mbps, -70dbm |
| Deep Sleep | 1.2mA | Average |
| Inrush current | 3000 mA | Max. |

The power consumption is standard related.

Bluetooth

| Vo | ltage | : | VDD |
|----|-------|---|-----|
|----|-------|---|-----|

| Operating Voltage | 3.3 Volt | +- 10% |
|-------------------|----------|--------|
|-------------------|----------|--------|

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| Current | | | | |
|------------|--------|---------|--|--|
| Transmit | 50 mA | Typical | | |
| Receive | 40 mA | Typical | | |
| Deep Sleep | 100 uA | Max | | |

4.3. COMPACTFLASH SPECIFICATION

4.3.1. DC ELECTRICALS

The DC specification is under 3.3 voltage. Over full range of values specified in the "Recommended Operation Condition" unless specified.

Power supply: VDD=3.3V

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|--------|---------------------|-----------|---------|-----|---------|-------|
| ViH | Input high voltage | | 0.5 VDD | - | VDD+0.5 | V |
| VIL | Input low voltage | | -0.5 | - | 0.35VDD | V |
| Vон | Output high voltage | | 2.4 | - | - | V |
| Vol | Output low voltage | | - | - | 0.4 | V |

4.3.2. AC ELECTRICALS

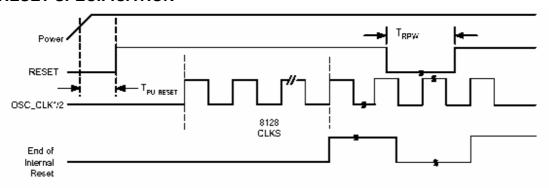
The DC specification is under 3.3 voltage. Over full range of values specified in the "Recommended Operation Condition" unless specified.

Power supply : VDD = 3.3V

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|--------|---------------------|----------------|------|-------|-----|-------|
| Іон | Input high voltage | =0.7 VDD | 11.3 | - | 32 | mA |
| lol | Input low voltage | =0.18VDD | 10.5 | - | 38 | mA |
| Vон | Output high voltage | 0.2VDD- 0.6VDD | 2.4 | 0.518 | 4.0 | V/ns |
| Vol | Output low voltage | 0.6VDD-0.2VDD | - | 0.592 | 4.0 | V/ns |

4.3.3. COMPACTFLASH PROTOCAL TIMING

4.3.3.1. RESET SPECIFICATION



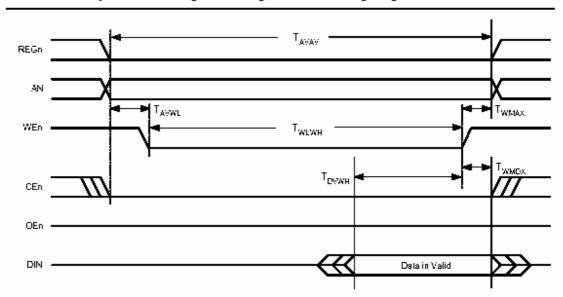
RESETh is not needed for proper operation due to internal power-on reset logic.

Input Reset Timing Requirement
Overfull range of values specified in the Recommended Operating Conditions unless otherwise specified.

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|------------------|-------------------|-----------|-----|--------|-----|-------|
| T _{RPW} | RESETnpulse width | | | 100 ns | | |

4.3.3.2. ATTRIBUTE MEMORY READ/WRITE TIMING SPECIFICATION

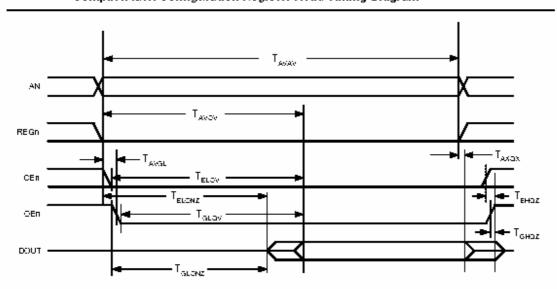
CompactFlash Configuration Register Write Timing Diagram



CompactFlash Write Timing Data Over full range of values specified in the Recommended Operating Conditions unless otherwise specified.

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|-------------------|------------------------|-----------|-----|-----|-----|-------|
| T _{AVAV} | Write Cycle Time | | 250 | - | _ | ns |
| TWLWH | Write Pulse Width | | 150 | | _ | ns |
| TAVWL | Address Setup Time | | 30 | - | _ | ns |
| T _{WMAX} | Write Recovery Time | | 30 | | _ | ns |
| Tovwh | Data Setup Time for WE | | 80 | | _ | ns |
| T _{WMDX} | Data Hold Time | | 30 | _ | _ | ns |

CompactFlash Configuration Register Read Timing Diagram



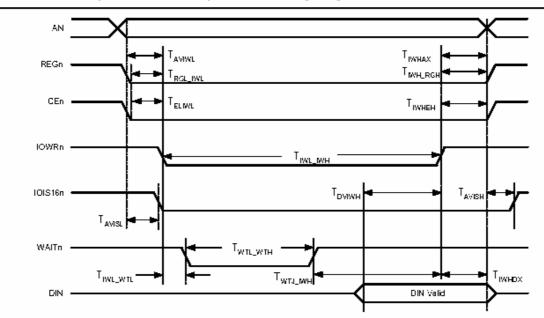
CompactFlash Read Tirming Data

Over full range of values specified in the Recommended Operating Conditions unless otherwise specified.

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|--------------------|--------------------------------|-----------|-----|-----|-----|-------|
| T _{ANAV} | Read Cycle Time | | 300 | _ | | ns |
| T _{AVQV} | Address Access Time | | | _ | 300 | ns |
| TELOV | Card Enable Access Time | | | _ | 300 | ns |
| T _{GLOV} | Output Enable Access Time | | | _ | 150 | ns |
| Тенаг | Output Disable Time from CE | | | - | 100 | ns |
| T _{GHQZ} | Output Disable Time from OE | | | _ | 100 | ns |
| T _{AVGL} | Address Setup Time | | 30 | - | | ns |
| TELONZ | Output Enable Time from CE | | 5 | _ | | ns |
| T _{GLONZ} | Output Enable Time from OE | | 5 | _ | | ns |
| T _{AXQX} | Data Valid from Address Change | | 0 | _ | | ns |

4.3.3.3. I/O READ/WRITE TIMING SPECIFICATION

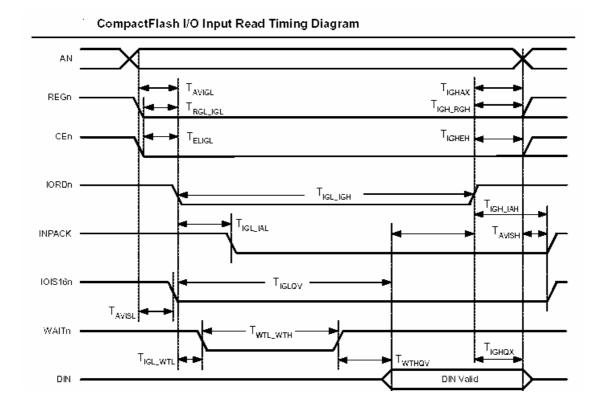
CompactFlash I/O Output Write Timing Diagram



CompactFlash I/O Output Write Timing Data

Over full range of values specified in the Recommended Operating Conditions unless otherwise specified.

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|----------------------|-----------------------------------|-----------|-----|-----|-----|-------|
| T _{DVIWH} | Data Setup Time Before IOWR | | 60 | | | ns |
| T _{IWHDX} | Data Hold Following IOWR | | 30 | | | ns |
| T _{IWL IWH} | IOWR Width Time | | 165 | | | ns |
| T _{AVIWL} | Address Setup Before IOWR | | 70 | | | ns |
| T _{IWHAX} | Address Hold Following IOWR | | 20 | | | ns |
| T _{ELIWL} | CE Setup Before IOWR | | 5 | | | ns |
| T _{IWHEH} | CE Hold Following IOWR | | 20 | | | ns |
| T _{RGL IWL} | REG Setup Before IOWR | | 5 | | | ns |
| T _{IWH RGH} | REG Hold Following IOWR | | 0 | | | ns |
| T _{AVISL} | IOIS16 Delay Falling From Address | | | | 35 | ns |
| T _{AVISH} | IOIS16 Delay Rising From Address | | | | 35 | ns |
| T _{IWL WTL} | Wait Delay Falling from IOWR | | | | 35 | ns |
| T _{WTJ IWH} | IOWR High from Wait High | | 0 | | | ns |
| T _{WTL} WTH | Wait Width Time | | | | 350 | ns |



CompactFlash I/O Input Read Timing Data

Over full range of values specified in the Recommended Operating Conditions unless otherwise specified.

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|----------------------|--------------------------------|-----------|-----|-----|-----|-------|
| T _{IGLQV} | Data Delay After IORD | | | | 100 | ns |
| T _{IGHQX} | Data Hold Following IORD | | 0 | | | ns |
| T _{IGL IGH} | IORD Width Time | | 165 | | | ns |
| T _{AVIGL} | Address Setup Before IORD | | 70 | | | ns |
| T _{IGHAX} | Address Hold Following IORD | | 20 | | | ns |
| T _{ELIGL} | CE Setup Before IORD | | 5 | | | ns |
| T _{IGHEH} | CE Hold Following IORD | | 20 | | | ns |
| T _{RGL IGL} | REG Setup Before IORD | | 5 | | | ns |
| T _{IGH RGH} | REG Hold Following IORD | | 0 | | | ns |
| T _{IGL IAL} | INPACK Delay Falling from IORD | | 0 | | 45 | ns |
| T _{IGH IAH} | INPACK Delay Rising from IORD | | | | 45 | ns |

4.4. WIRELESS SPECIFICATIONS

The WM-BG-MR-01 module comply with the following features and standards;

| Features | Description |
|-------------------|---|
| WLAN Standards | IEEE 802 Part 11b/g (802.11b/g) |
| Bluetooth | Bluetooth [™] 1.1 and 1.2 compliance |
| Antenna Connector | Two antenna connectors support 802.11b/g and BT one for each. |
| Coexistence | Hardware signaling |
| Frequency Band | 2.400 – 2.484 GHz |

4.5. RADIO SPECIFICATIONS 802.11G

| Description | | |
|---|--|--|
| 2.4000 - 2.497 GHz (2.4 GHz ISM Band) | | |
| 14 channels | | |
| OFDM, DSSS (Direct Sequence Spread Spectrum), DBPSK, DQPSK, CCK, 16QAM, 64QAM | | |
| 1,2, 5.5,11,6,9,12,24,36,48,54 Mbps | | |
| - 10dBm (with PER < 8%) | | |
| 14 dBm +1.5/-1.0 dBm for 1, 2, 5.5, 11Mbps | | |
| 14 dBm +/- 1.0 dBm for 6, 9Mbps 12 dBm +/- 1.0 dBm for > 12Mbps | | |
| | | |

| Receiver Characteristics (3.3V, 25 degree C) | Typical | Max. | Unit |
|--|---------|------|------|
| PER <8%, Rx Sensitivity @ 11 Mbps | -87 | -85 | dBm |
| PER <8%' Rx Sensitivity @ 5.5 Mbps | -89 | -87 | dBm |
| PER <8%, Rx Sensitivity @ 2 Mbps | -90 | -88 | dBm |
| PER <8%, Rx Sensitivity @ 1 Mbps | -92 | -90 | DBm |
| PER <10%, Rx Sensitivity @ 54 Mbps | -72 | -70 | DBm |

4.6. RADIO SPECIFICATIONS 802.15 BLUETOOTH

The Radio specification is compliant with the Bluetooth™ 1.1 and 1.2 class 2 specification

| Features | Description |
|--------------------|-------------------|
| Frequency Band | 2400 ~ 2483.5 MHz |
| Number of Channels | 79 channels |

| Modulation | FHSS (Frequency Hopping Spread Spectrum), GFSK |
|-------------------|--|
| Antenna Connector | One Hirose W.FL –R –SMT(10) RF connector |

4.7. BLUETOOTH RADIO CHARACTERISTICS

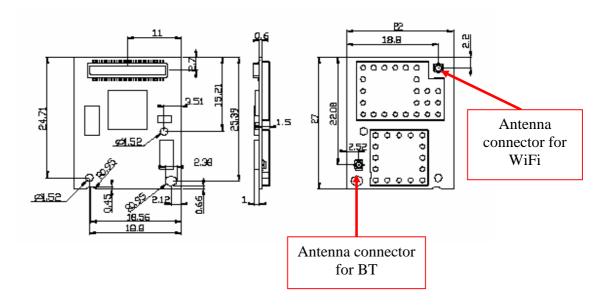
| Features | Description | | |
|-----------------------|---|--|--|
| Maximum Receive Level | 3 dBm (Typical) | | |
| Output Power | 1 dBm (Typical) | | |
| Sensitivity | -81 dbm @ 0.1% BER @ 25 ° Celsius (Typical) | | |

4.8. DIMENSIONS, WEIGHT AND MOUNTING

The following paragraphs provide the requirements for the size, weight and mounting of the WM-BG-MR-01 module.

4.8.1. DIMENSIONS

The size and thickness of the WM-BG-MR-01 module is listed below:



The height – will be finalized after the module design is frozen.

4.8.2. WEIGHT

Weight shall not exceed 10 gram including the shielding.

4.8.3. MOUNTING

The WM-BG-MR-01 module is B2B mounted type component. The B2B connector and additional screw hole provide mounting mechanism to secure the WM-BG-MR-01 module against vibration and shock on the host system.

4.9. SHOCK AND VIBRATION

All shock and vibration test will be performed by using an interface adapter card. Additional shock and vibration tests can be performed – on request – by using the real host being PDA, Textbook or any other application. The interface card will provide mounting facility base on the recommendation /application guide provided.

Vibration

| Vibiation | |
|-----------------|---|
| Operating | Frequency sweep from 3-150-3 Hz with a constant 0.25 G |
| | input |
| Non-Operational | Frequency sweep from 3-150-3 Hz with a constant 0.5 G input |
| Shock | |
| Operational | 25 G peak within 3.75 msec in normal base position |
| Non-Operational | 65 G peak in 3.75 msec in normal base position. |
| | 30 G within 8 msec square or trapezoidal shock in + and - |
| | direction along the 3 axis. (Total 6 shocks) |

Note: Above tests are executed without packaging material.

5. COMPATIBILITY AND INTEROPERABILITY

5.1 WIRELESS LAN

5.1.1 FEATURES

- 802.11 b/g
- WEP Encryption (64bit/128bit)
- IEEE power save mode
- Deep Sleep Mode
- Infrastructure & Ad-Hoc Mode
- Rate adaptation
- WPA TKIP security
- WPA2 (Linux ready)
- 802.1x support
- AES

5.1.2 OPERATING SYSTEMS

- WinCE 4.2/5.0, Windows Mobile 2003, Windows Mobile 5.0
- Certification tool support
- Configuration Utility support

• Linux: Slakeware 9.1, Fedora Core 1.0

Kernel: 2.4.22 & above Certification tool support

Configuration Utility support (Wireless extension support)

5.2 BLUETOOTH KEY FEATURES OF THE HCI STACK

5.2.1 NEW BLUETOOTH V1.2 MANDATORY FUNCTIONALITY

- Adaptive Frequency Hopping (AFH)
- Faster Connections
- Flow and Flush Timeout
- LMP Improvements
- Parameter Ranges

5.2.2 OPTIONAL V1.2 FUNCTIONALITY SUPPORTED

- Extended SCO (eSCO), eV3+CRC,eV4,eV5.
- Scatter mode
- LMP Absence Masks, Quality of service and SCO handle
- L2CAP flow and error control
- Synchronisation

5.2.3 STANDARD BLUETOOTH FUNCTIONALITY

- Bluetooth components: Baseband (including LC), LM and HCI
- Standard USB v2.0 and UART (H5) HCI Transport Layers
- All standard radio packet types
- Full Bluetooth data rate, up to 723.2kbps asymmetric
- Operation with up to seven active slaves
- Maximum number of simultaneous active ACL connections: 7
- Maximum number of simultaneous active SCO connections: 3
- Operation with up to three SCO links, routed to one or more slaves
- Scattermet 2.5 operation
- All standard SCO voice coding, plus "transparent SCO"
- Standard operating modes: page, inquiry, page-scan and inquiry-scan
- All standard pairing, authentication, link key and encryption operations
- Standard Bluetooth power saving mechanisms: Hold, Sniff and Park modes, including "Forced Hold"
- Dynamic control of peers' transmit power via LMP
- Master/Slave switch
- Broadcast
- Channel quality driven data rate
 - All standard Bluetooth Test Modes

6. CONFIGURABILITY

No user configuration needed. The CIS and MAC Address will be loaded during production of the WM-BG-MR-01 module.

7. OPERATING SYSTEM COMPATIBILITY

Drivers are supported for the following OS:

- Windows CE 3.0 /4.2/5.0, PPC2003, 2004, 2005
- Linux.

8. LEGAL, REGULATORY & OTHER TECHNICAL CONSTRAINTS

The WM-BG-MR-01 module is pre-tested to ensure that all requirements met as set forth in the following sections.

Final certification (module certification) requires the antenna of targeted system with a lead-time of 6 weeks. The product deliverable shall be a pre-tested WM-BG-MR-01 module. No module level certification on WM-BG-MR-01 module.

8.1. EMC

The module will be pre-tested to ensure that we can certify the product in the following countries when final certification will be performed on products and or platforms.

- US. FCC CFR47 Part 15-B, Class B
- Canada. CSA C22.2, Class B
- ♣ Europe. 89/336/EEC, EMC Directive, including CE Mark
- ETS300 826, EMC standard for 2.4GHz wideband transmission systems
- ♣ EN55022, Class B (Emissions)
 EN50082-1 (Immunity)
 EN61000-3-2 (Harmonic AC current emissions)
- ♣ Japan. VCCI Standard, Class 2 (Emissions)
- Korea (MIC)

8.2. PRODUCT SAFETY SPECIFICATION

The WM-BG-MR-01 module is tested and pass successfully the following criteria; The testing is to assure the quality of safety requirement on module. Final certification will be conducted on system level.

- UL1950 /CSA C22.2.950
- **4** EN60 950 (IEC 950)
- ♣ CB scheme certification from National certification body as listed in CB bulletin No. 96A.

4

8.3. COMPONENT SPECIFICATION

All components used in this device meet the following component approval requirements.

PRINTED WIRING BOARDS: The printed wiring boards shall be Underwriters Laboratories Inc. "Recognized Component" (ZPMV2) under the category for Printed Wiring Boards, and shall be flammability rated 94V-1 or less flammable. The board material shall be rated 130°C minimum.

<u>CONNECTORS</u>: Any connectors, if used, shall be Underwriters Laboratories, Inc. "Recognized" (ECBT2/RTRT2) in accordance with the requirements in the UL Standard for Safety, UL 498. Any polymeric connector housing shall be molded of plastics rated UL 94V-2 or less flammable when tested to UL 94.

<u>WIRING</u>: Any wiring material, if used, shall be UL Recognized Component Appliance Wiring Material (AVLV2). Wire shall be minimum rated 30V, 105°C.

<u>PLASTIC PARTS</u> - Any plastic parts used shall be molded of plastics that are UL "Recognized" (QFMZ2) and rated UL 94V-2 or less flammable when tested to UL 94.

<u>"PB FREE"</u> - The entire component Suppliers has to support Green requirement base on USI's policy. All of the components which including process and materials has to be Lead Free.

8.4. RADIO REQUIREMENTS AND APPROVALS

The WM-BG-MR-01 module is tested with adapter card to comply with following standard. The testing is to assure the performance of regulatory requirement on module. Final certification will be conducted on system level.

♣ US/CAN: FCC CFR47 Part 15.247

♣ Japan: TELEC

♣ Korea: MIC

Europe: ETS 300-328 V1.6.1

8.5. PRODUCT MARKING

The Module is marked by laser marking which containing the following information:

Description: WM-BG-XX-XX Serial number: yyllwkxxxx

Revision: format to follow USI revision level in PDM System

For the serial number the following format will be followed:

yy =last two digits of current year

// = Assembly Location:

UT = USI Taiwan UM = USI Mexico UC = USI China

wk = current week (week period = starting on Monday)

xxxx = consecutive number, starting at 0000 at beginning of each week.

8.6. ENVIRONMENTALLY SAFE MATERIAL RESTRICTIONS

The use of polychlorinated biphenyls (PCB's) is prohibited (specifically) as dielectric in capacitors or transformers.

Electrolytic capacitors shall not be composed of any quaternary salt ammonium and/or gamma-butyrolactone (i.e. no el caps allowed).

No CFC's (chlorofluorocarbons) shall be used anywhere in the manufacture of this product.

The use of tantalum capacitors should be minimized in any product of the product family [including the power-supply]. Where the use of tantalum caps cannot be avoided, provisions must be made in the manufacturing process to prevent reverse polarization.

The WM-BG-MR-01 module hardware design should take the safety of operation into consideration and prevent the potential risk on Labor safety for manufacturing process.

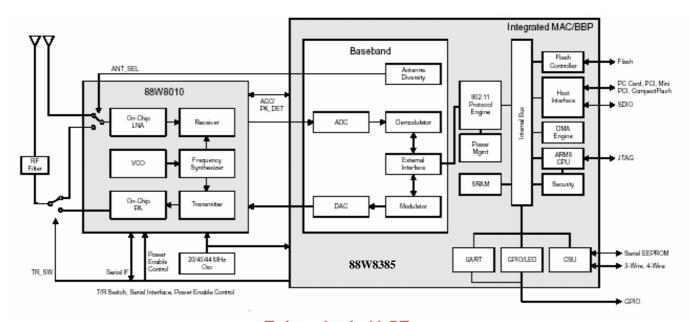
9. FUNCTIONAL DESCRIPTION

The WM-BG-MR-01 module provides and interfaces between Compaq Flash or PC Card Interface, SDIO, SPI which suitable for wide range high-end processors or low cost ARM7 or other similar type of processors.

The core of the WM-BG-MR-01 module is the Marvell 88W83 Chipset solution.

The module is design base on the Marvell Libertas solution which contain the flip chip package MAC/BB chip - 88W8385, The transceiver 88W8015 low profile package IC to reduce the size of module. All the other components can be implement by all means to reach the mechanical specification.

A simplified block diagram of the WM-BG-MR-01 module is depicted in the Fig. below.



To be updated with BT

9.1. HARDWARE

The following sections provide the requirements for the different physical interfaces of the wireless module:

- Host Interface
- Antenna connections
- LED control signal
- Bluetooth WiFi coexistence control signals



9.2. HOST INTERFACE

The host interface will be compatible with CompactFlash (PCMCIA) standard, 16 bit I/O bus. Signals which are not used won't be routed to the physical interface (connector). The host interface of Combo SiP Bluetooth portion is compliant with UART interface, the default baud rate setting is 115.2kbps and the optional range is from 9.6kbps to 921.6kbps.

On Board connector

Molex 53794-0608 or 55560-0607

[Socket, 60 pins, with positioning protection, stack height which is able to support 1.5 mm]





Host System:

Host System Connector

Molex 54722-0607 [Header, 60 pins, with positioning protection, stack height 1.5mm]



Pin definition

[...] means optional function of the pin.

PD: Signal pull down internally in the chip by 50K ohm while initialization. **PU**: Signal pull up internally in the chip by 100K ohm while initialization.

5VT: 5 Volt tolerance pin

xxx_B : Signal pins end with _B are "active high"

| Pin # | Definition | Draft Description Type | | Туре |
|-----------------|---------------|------------------------|--------------------------|-------------|
| WM-BG- MR-01 | CF+ interface | | | |
| 1 | GND | GND | GND | |
| 2 | D03 | HD3 | | IO, PU, 4mA |
| | | | CompactFlash Data bit[3] | |
| 3 | D04 | HD4 | CompactFlash Data bit[4] | IO, PU, 4mA |
| 4 | D05 | HD5 | CompactFlash Data bit[5] | IO, PU, 4mA |

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| 5 | D06 | HD6 | CompactFlash Data bit[6] | IO, PU, 4mA |
|----|----------------|---------------|--|------------------|
| 6 | D07 | HD7 | CompactFlash Data bit[7] | IO, PU, 4mA |
| 7 | -CE_1 | HCE1_B | Card Enable1 is driven by the host system and is used as select strobe in both I/O and memory mode. Enables even numbered address bytes. | |
| 8 | A10 | HA10 | CompactFlash Address bit [10]. See address bit [0] description. | Input, PU |
| 9 | -OE SD_CMD | HOE_B | OUTPUT ENABLE is driven by the host during a memory Read Access. SD_CMD: SDIO Command Line | Input, PU |
| 10 | A09 SD_DAT2 | НА9 | CompactFlash Address bit [9]. See address bit [0] description. SD_DATA2: SDIO DATA LINE 2 | Input, PU |
| 11 | A08 | HA8 | | Input, PU |
| 12 | A07 | HA7 | | Input, PU |
| 13 | VCC | VCC_WLA N | 3.3V supply voltage for WLAN | Input 3.3 V |
| 14 | A06 | HA6 | CompactFlash Address bit [6]. See address bit [0] description. | Input, PU |
| 15 | A05 | HA5 | | Input, PU |
| 16 | A04 | HA4 | CompactFlash Address bit [4]. See address bit [0] description. | Input, PU |
| 17 | A03 | HA3 | CompactFlash Address bit [3]. See address bit [0] description. | Input, PU |
| 18 | A02 | HA2 | CompactFlash Address bit [2]. See address bit [0] description. | Input, PU |
| 19 | A01 | HA1 | CompactFlash Address bit [1]. See address bit [0] description. | Input, PU |
| 20 | A00 | HAO | CompactFlash Address bit [0]. The address lines A[10:00] along with the REG signal are used to select the following: • The I/O port address register • The memory mapped port address register • A byte in the card's information structure (CIS) | |
| 21 | D00 | HD0 | CompactFlash Data bit[0] | IO, PU, 4mA |
| 22 | D01 | HD1 | CompactFlash Data bit[1] | IO, PU, 4mA |
| 23 | D02 | HD2 | CompactFlash Data bit[2] | IO, PU, 4mA |
| 24 | -IOIS16 | HIOIS16_ B | I/O port is 16bits | Out, 6mA |
| 25 | -CD2 | CD2 | Normal operation, this pin is functionally for card detection. | Out, 6mA |
| 26 | N/A | TXD_B | UART Data output, Active High | Output, WPU, 1µA |
| 27 | N/A | RTS_B | UART Request to send, Active low, Tristatable, Pulled-up Output, WPU, 1µA | |
| 28 | N/A | PCM_In | Synchronous Data input | |
| 29 | N/A | VCC_WLA | 3.3V power supply for WLAN | Input |

| 30 | GND | GND | | | |
|----|------------------|----------------|--|---------------|--|
| 31 | GND | GND | | | |
| 32 | D10 | HD10 | CompactFlash Data bit[10] IO, PU, 4mA | | |
| 33 | D09 | HD9 | CompactFlash Data bit[9] | IO, PU, 4mA | |
| 34 | D08 | HD8 | CompactFlash Data bit[8] | IO, PU, 4mA | |
| 35 | -STSCHG | HSTSCHG B | Card status changed | Output, 4mA | |
| 36 | -SPKR | PCM_Sync | Synchronous Data strobe | Input PD, 4mA | |
| 37 | -REG | HREG_B | Register select and I/O enable | Input, PU | |
| 38 | -INPACK | HINPACK_ B | INPUT ACKNOWLEDGE is driven by WM-BG-MR-01. Is asserted when the device is selected and the device is responding to an I/O Read command. | Output, 2mA | |
| 39 | -WAIT | HWAIT_B | HWAIT_B is driven by WM-BG-MR-01 and allows for extending the memory or I/O cycle | Output, 4mA | |
| 40 | RESET | HRESET | Used to asynchronously reset WLAN. High active. | Input, PU | |
| 41 | N/A | N/A | Reserved. Keep connection open on Host N/A side | | |
| 42 | N/A | WLAN_LED _B | WLAN LED control signal, driven the LED indicating the link status of WLAN. Active low. | | |
| 43 | N/A | PCM_OUT | Synchronous Data output | | |
| 44 | IREQ | IREQ_B | Ready/Busy or Interrupt request. In memory mode, this signal indicates the ready or busy status of the card. When held high, the card is ready to accept a new data transfer. When held low the card is busy. In I/O mode, this signal is used to indicate an interrupt condition. | | |
| 45 | -WE | HWE_B | WRITE ENABLE is driven by the host Input, PU during a memory Write Access | | |
| 46 | -IOWR SD_DAT3 | HIOWR_B | | | |
| 47 | -IORD SD_DAT1 | HIORD_B | I/O Read Strobe is driven by the host Input, PU and is asserted when the host wants to read from an on-chip I/O register SD_DAT1 : SDIO DATA LINE 1 | | |
| 48 | -VS1 | -VS1 | This pin is connected to Ground on module to indicate the voltage of this GND module is 3.3V card. | | |
| 49 | -CE2 SD_CLK | HCE2_B | CARD ENABLE2 is driven by the host system and is used as select strobe in both I/O and memory mode. Enables odd numbered address bytes SD_CLK: SDIO CLOCK | | |

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| 50 | D15 | HD15 | CompactFlash Data bit[15] IO, PU, 4mA | |
|----|----------------|--|---|-------------|
| 51 | D14 | HD14 | CompactFlash Data bit[14] IO, PU, 4mA | |
| 52 | D13 | HD13 | CompactFlash Data bit[13] IO, PU, 4mA | |
| 53 | D12 | HD12 | CompactFlash Data bit[12] | IO, PU, 4mA |
| 54 | D11 | HD11 | CompactFlash Data bit[11] | IO, PU, 4mA |
| 55 | N/A | BT_LED_B | BT LED control signal which drives the Output, 4mA LED to indicate the activity of Bluetooth. Active low. | |
| 56 | N/A | RXD_B | UART Data input, active High, Pulled Input, WPD, 1µA down (weak) | |
| 57 | N/A | CTS_B | UART Clear to Send, Active low, Pulled Input, WPD, 1µA down (weak) | |
| 58 | N/A SD_DATO | PCM_CLK Synchronous Data clock SD_DAT0: SDIO DATA LINE 0 | | |
| 59 | N/A | VCC_BT | 3.3V supply voltage for Bluetooth Input | |
| 60 | GND | GND | | |

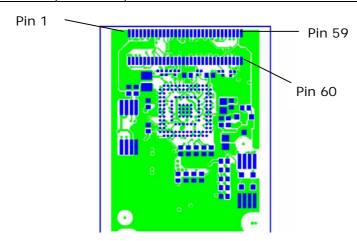


Fig 1: Pin 1 assignment and indication Drawing (To be updated with latest design)

9.2.1. LED INTERFACE

The Wireless Module will provide two control signals to the host and capable to drive an LED to indicate the connectivity and operating status.

The WM-BG-MR-01 have 2 LED's (output) via 60 pins connector for feedback to the user on the current WLAN activity state. The signaling will reflect status / activity as described in the table below. Those two signals are provided via the board to board connector with the following pin assignment.

|--|

| 42 | - | Check firmware specification of GPIO(1) with Marvell |
|----|--------------|--|
| 55 | BT_LED_B | Link activity of Bluetooth |

9.2.2. ANTENNA INTERFACE

No antenna diversity supported on the Wireless Module.

The output impedance of the cable is 50 Ohms.

Antenna Connector: *Hirose W-FL-R-SMT(10)*

9.2.3. BLUETOOTH INTERFACE

There are interfaces signal to routed between WiFi and Bluetooth to provide coexistence with 802.15 Bluetooth modules.

The BT co-existence interface supported, which is 2 Wire CSR co-existence.

The control signals are provided via the 60 pins B2B connector with the interface defined as below:

| Symbol | Interface | "Signal name" & description |
|-------------|------------|--|
| BTACT | 2 Wire-CSR | "BT _Priority" This pin indicates to WLAN BCA device that BT module is active or will soon be active to TX/RX stage. |
| WLAN_active | 2 Wire-CSR | "Wlan_Active", This pin indicates to BT module that WLAN is active or will soon be active to TX/RX stage. |

Note 1: "WLAN BCA" device is a functional block in 88W8385 works as Bluetooth co-existence management .

9.3. SOFTWARE

The following source code will be provided for porting to the embedded system under the SLA with chipset supplier

Linux source code

Source code of development utility base on Windows CE

10. DESIGN FOR EXCELLENCE (DFX)

10.1. TESTABILITY

The WM-BG-MR-01 module can be tested on the by using adapter card or similar interface. The adapter card must be such that from the FTS the WM-BG-MR-01 module is seen and recognized as PC Card or Compaq Flash.

No additional test pins are required to support in-circuit testing.

10.2. LOGISTICS

All customer specific requirements – customization – will be implemented at the highest possible level to support build to order and keep the number of modules in SMT to a minimum. Additional module variants might be added base on business potential.

11. HUMAN FACTORS

Due to the nature of this product (embedded module) no human factors required

12. INDUSTRIAL DESIGN

Due to the nature of this product (embedded module) no industrial design requirements are required.

13. RELIABILITY

The WM-BG-MR-01 module guarantee an MTBF of 150,000 hrs based on an ambient temperature and workload of 2,920 hours. The workload is based on a unit working for 8 hours per day, 365 days per year.

The MTBF estimation base on is Bell code standard, Class II.

14. PACKAGE

To be updated.

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